



Title: Microcap Wafer Bonding Method And Apparatus

Inventor: R. Shane Fazzio

Attorney Docket: 10030899-1

REPLACEMENT SHEET

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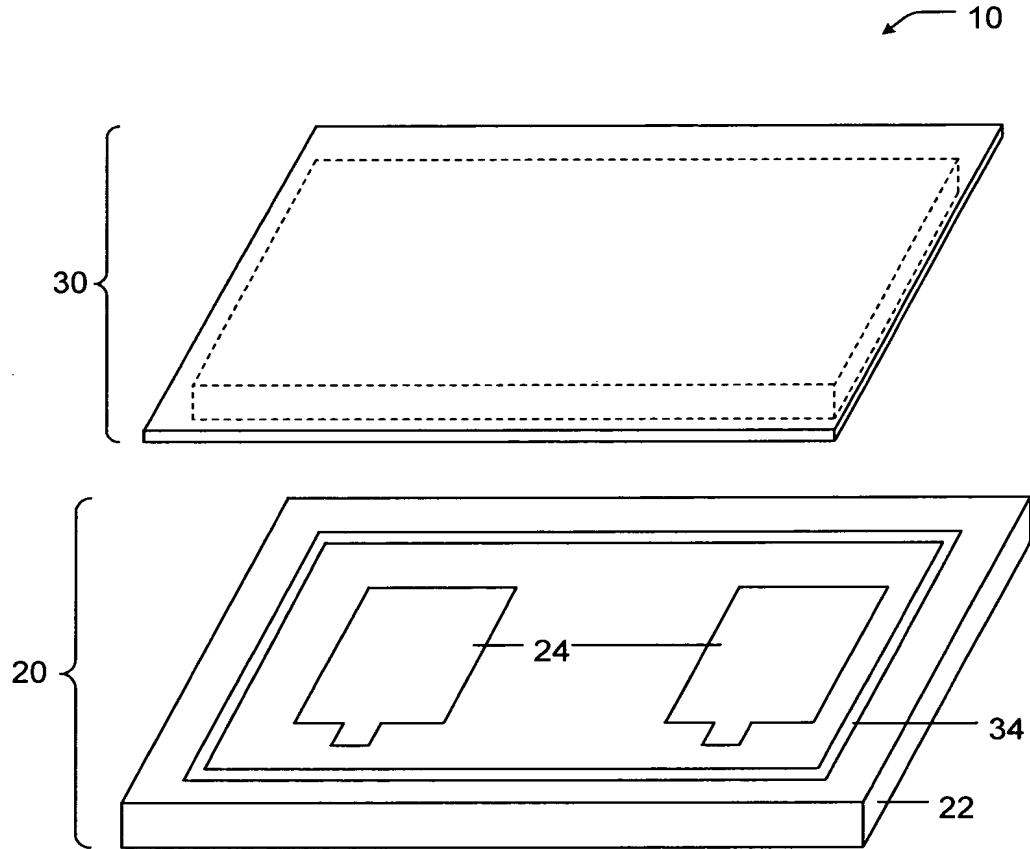


FIG. 1 (Prior art)

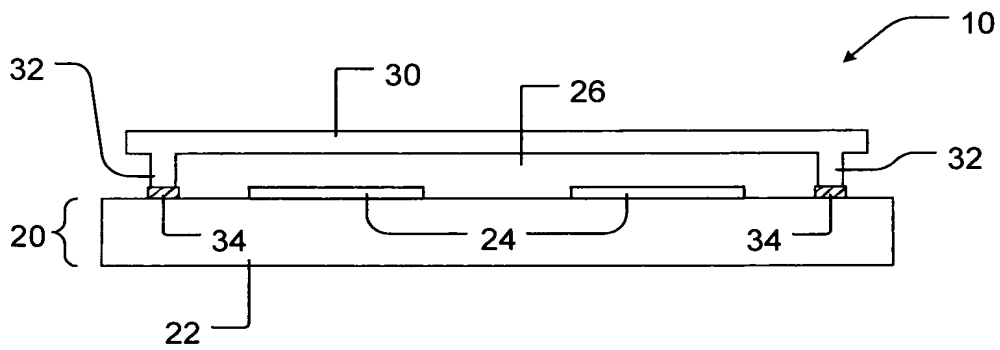


FIG. 2 (Prior art)

